

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Hembree et al.

Serial No.: 10/651,664

Filed: August 29, 2003

For: METHOD AND PROCESS OF CONTACT TO HEAT SOFTENED

SOLDER BALL ARRAY

Confirmation No.: 9327

Examiner: Unknown

Group Art Unit: 3742

Attorney Docket No.: 2269-3634.4US

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents,

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March 1, 2004 Date

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Name (Type/Print)

PRELIMINARY AMENDMENT

Mail Stop Non-Fee Amendment Commissioner for Patents P.O. Box 1450 Alexandria, Virginia 22313-1450

Sir:

Prior to examination of the above-referenced patent application on the merits, entry of the amendments as set forth herein is respectfully solicited.

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing which begins on page 4 of this paper.

Remarks begin on page 8 of this paper.